PCN Number:	2019	909090	001		PCN Date:		Oct. 1, 2019		
Title: Datasheet for	Datasheet for TPS1663								
<b>Customer Contact:</b>	PCN Manager				Dej	t: Quality Se	vices		
Proposed 1 <sup>st</sup> Ship Da				, 2020			, , ,		
Change Type:			,	-					
Assembly Site				Design			Wafer Bump Site		
Assembly Process		$\boxtimes$	Data Sheet			Wafer Bump Mate	rial		
Assembly Materials			Part number change			Wafer Bump Process			
Mechanical Specification			Test Site			Wafer Fab Site			
Packing/Shipping/Labeling			Test Process			Wafer Fab Materia	ıls		
							Wafer Fab Process	5	
Notification Details									
Description of Change: Texas Instruments Incorporated is announcing a change.									
The product datasheet(s) is being updated as summarized below.  TEXAS INSTRUMENTS  SLVSET9D – SEPTEMBER 2018 – REVISED AUGUST 2019									
Changes from Revision C (March 2019) to Revision D Page									
Changed the absolute maximum voltage in Features									
Changed the adjustable output power limiting in Features									
Changed the Absolute Maximum Ratings IN, P_IN, OUT, UVLO, FLT, PGOOD maximum input voltage									
Added T <sub>A</sub> = 25°C to the Absolute Maximum Ratings IN, P_IN (10ms transient) input voltage									
Changed the V <sub>(OVPF)</sub> maximum in Electrical Characteristics     Changed V <sub>(SEL_PLIM)</sub> , I <sub>(PLIM)</sub> , and I <sub>(dVdT)</sub> minimum and maximum									
Changed the P <sub>(PLIM)</sub> mining	num, ty	picai, and	max	ımum				6	
The datasheet number Device Family	WIII b	e chan	ging	. Change From:			Change To:		
-							-		
TPS1663				SLVSET9C			SLVSET9D		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/TPS1663									
				datasheet links p	rovided.				
Reason for Change:				datasheet links p	rovided.				
Reason for Change: To accurately reflect de	duct/T	PS166	<u>3</u>		rovided.				
	duct/T	PS166	3 erist	tics.		oility	(positive / nega	tive):	
To accurately reflect de	evice o	charact	3 erist	tics.	or Relial	oility	(positive / nega	tive):	
To accurately reflect de Anticipated impact o	evice on Fit,	charact Form,	erist	tics. nction, Quality nges as indicated	or Relial	oility	(positive / nega	tive):	
To accurately reflect de  Anticipated impact o  Electrical specification p	evice on Fit,	charact Form,	erist	tics. nction, Quality nges as indicated	or Relial	oility	(positive / nega	itive):	
To accurately reflect de  Anticipated impact o  Electrical specification p  Changes to product i	evice on Fit,	charact Form,	erist	tics. nction, Quality nges as indicated	or Relial	oility	(positive / nega	tive):	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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